

# **Product Compliance Declaration**

Please see <a href="https://www.molex.com">www.molex.com</a> for the most up-to-date information.

# **Contact Information**

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

**Part Information** 

Part Name KK 100 HDR FRLK RTAN 04 CKT GOLD

# **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
KK 100 HDR FRLK RTAN 04 CKT GOLD	Assembly		100	0.517089
KK 100 Header FrLk 04 ckt	Component		47.3806	0.245
PA66/6 NATURAL	Material	Material 47.3806		0.245
PA66/6	Substance		41.6949	0.2156
Flame Retardant, ISO 1043-4 FR(30)	Substance		4.7381	0.0245
Further Additives, not to declare	Substance	system	0.9476	0.0049
.740 x .0261 Sq Brass Bando Pin 20SAu	Assembly		52.6194	0.272089
.740 x .0261 Sq Brass Bando Pin Unplated	Component		51.055	0.264
Cartridge Brass 70% Unplated	Material		51.055	0.264
Copper	Substance	7440-50-8	35.7385	0.1848
Zinc (metal)	Substance	7440-66-6	15.3165	0.0792
Tin Plating	Material		0.3103	0.001604
Tin	Substance	7440-31-5	0.3103	0.001604

#### Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel Plating	Material		1.083	0.0056
Nickel	Substance	7440-02-0	1.0829	0.005599
Further Additives, not to declare	Substance	system	0.0001	6E-07
Gold Plating	Material		0.1711	0.000885
Cobalt	Substance	7440-48-4	0.0004	0.000002
Nickel	Substance	7440-02-0	0.0004	0.000002
Gold	Substance	7440-57-5	0.1703	0.00088

# **ROHS Declaration Information**

**Regulatory Revision** EU 2015/863

Compliance Status Compliant

**Contained Substances Exceeding Threshold** 

None

**Exemptions** 

None

# **REACH-SVHC Declaration Information**

**Regulatory Revision** D(2020)9139-DC (19 Jan 2021)

**Contained Substances Exceeding Threshold** 

None

## **GADSL Declaration Information**

Regulatory Revision GADSL imported from IMDS

#### **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes
nickel powder [particle diameter < 1 mm]	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes

<sup>\*</sup>Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

# **Exemptions**

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	34 Not applicable
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

# **HFLH** Declaration Information

Regulatory Revision IEC 61249-2-21

## **Contained Substances Exceeding Threshold**

None

## **China ROHS Declaration Information**

Part Number	0022122044							
Part Name	KK 100 HDR FRLK RTAN 04 CKT GOLD	<b>(e)</b>						
Part Information	on			Ha	zardous S	Substance	s	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
KK 100 HDR	FRLK RTAN 04 CKT GOLD		0	0	0	0	0	0
KK 100 Head	ler FrLk 04 ckt		0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
.740 x .0261 Sq Brass Bando Pin 20SAu	0	0	0	0	0	0
.740 x .0261 Sq Brass Bando Pin Unplated	0	0	0	0	0	0

# **Process Information**

Component Plating / Surface Finish	MSn-Ni
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	235
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Apr 25, 2021